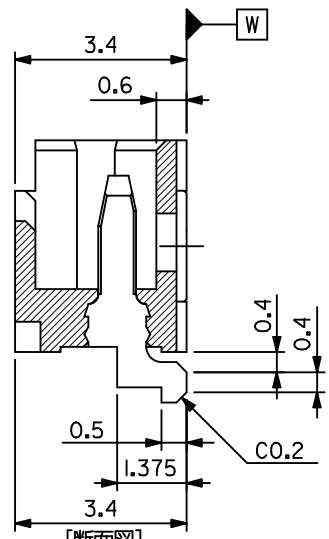
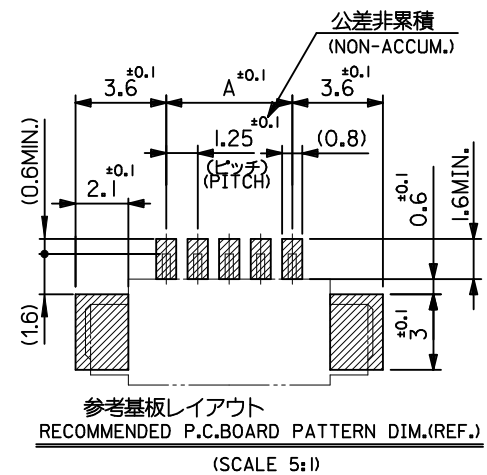
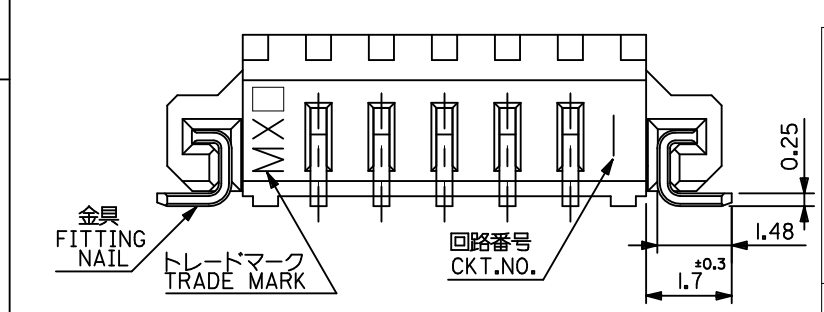
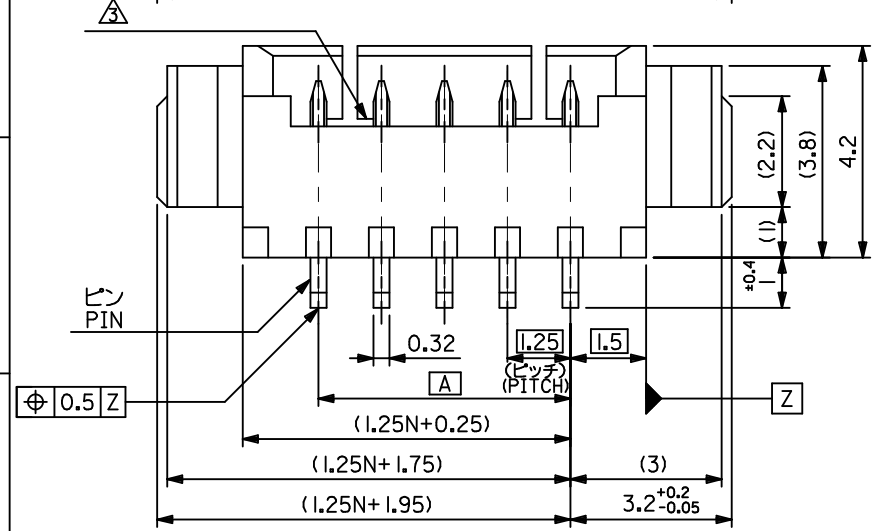
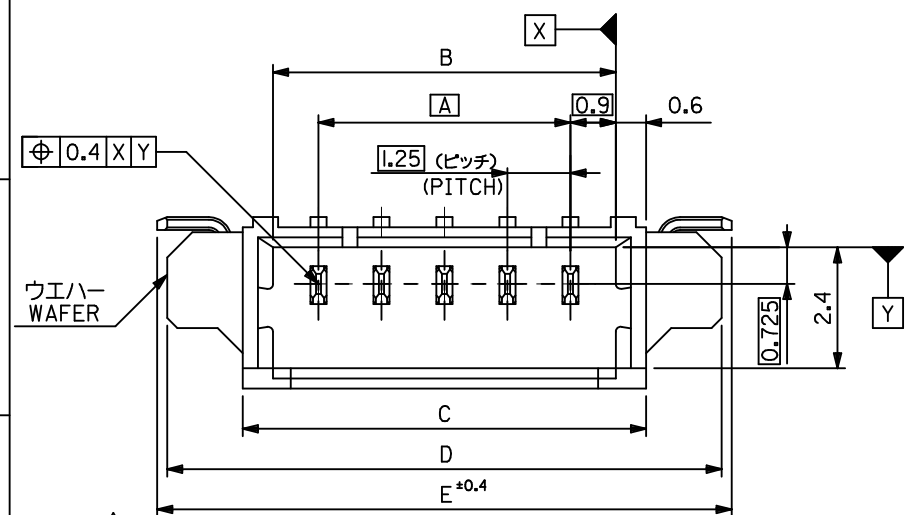




注記 NOTES

1. 嵌合相手: 51021 シリウス
MATES WITH: 51021 SERIES

2. 材質 MATERIAL
ウエハー: NYLON46, UL94V-0
ピン: リン青銅, 半田メッキ
PIN: PHOS-BRO., Sn-Pb(9:1) 3 μmMIN.
OVER Cu 1 μmMIN.
PLATING
金具: リン青銅, 半田メッキ
FITTING NAIL: PHOS-BRO., Sn-Pb(9:1) 2 μmMIN.
OVER Cu 1 μmMIN.
PLATING

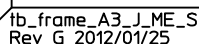
△ ロック窓は2、3極は1箇所、4極以上は2箇所とする。
LOCKING WINDOW: ONE PLACE FOR 2 AND 3 CKT. AND TWO PLACES FOR MORE THAN 3 CKT.

4. ソルダータール部のズレ量及び金具 (補強板) のズレ量は基準面 W に対し、上方向 0.05 MAX.、下方向に 0.1 MAX. とする。
OFFSET BETWEEN BASIS PLANE W TO SOLDER TAIL BOTTOM AND FITTING NAIL BOTTOM: UPPER SIDE: 0.05MAX. LOWER SIDE: 0.1MAX.

23.9	23.5	20.5	19.3	17.5	53261-1510	15
22.65	22.25	19.25	18.05	16.25	-1410	14
21.4	21	18	16.8	15	-1310	13
20.15	19.75	16.75	15.55	13.75	-1210	12
18.9	18.5	15.5	14.3	12.5	-1110	11
17.65	17.25	14.25	13.05	11.25	-1010	10
16.4	16	13	11.8	10	-0910	9
15.15	14.75	11.75	10.55	8.75	-0810	8
13.9	13.5	10.5	9.3	7.5	-0710	7
12.65	12.25	9.25	8.05	6.25	-0610	6
11.4	11	8	6.8	5	-0510	5
10.15	9.75	6.75	5.55	3.75	-0410	4
8.9	8.5	5.5	4.3	2.5	-0310	3
7.65	7.25	4.25	3.05	1.25	53261-0210	2
E	D	C	B	A	ENG. NO.	極数 CKT.

【断面図】
[CROSS SECTION]

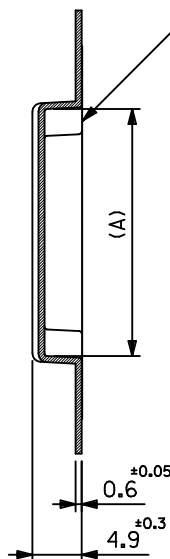
REVISED EC NO: J2012-1315 2012/04/17 DRWN: NITO CHKD: KASAKAWA 2012/04/17 APPR: YOITO 2012/04/26	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1		DESIGN UNITS METRIC		THIRD ANGLE PROJECTION	
		10 UNDER ±0.2		DRAWN BY NITO		DATE 2012/04/17		TITLE 1.25 WIRE TO BOARD WAFER ASS FOR SMT RIGHT ANGLE molex SD-53261-054			
		10 OVER 30 UNDER ±0.25		CHECKED BY KASAKAWA		DATE 2012/04/17					
		30 OVER ±0.3		APPROVED BY YOITO		DATE 2012/04/26					
		ANGULAR ±3 °		MATERIAL NO. SEE DRAWING		DOCUMENT NO. SD-53261-054		SHEET NO. 1 OF 1			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							



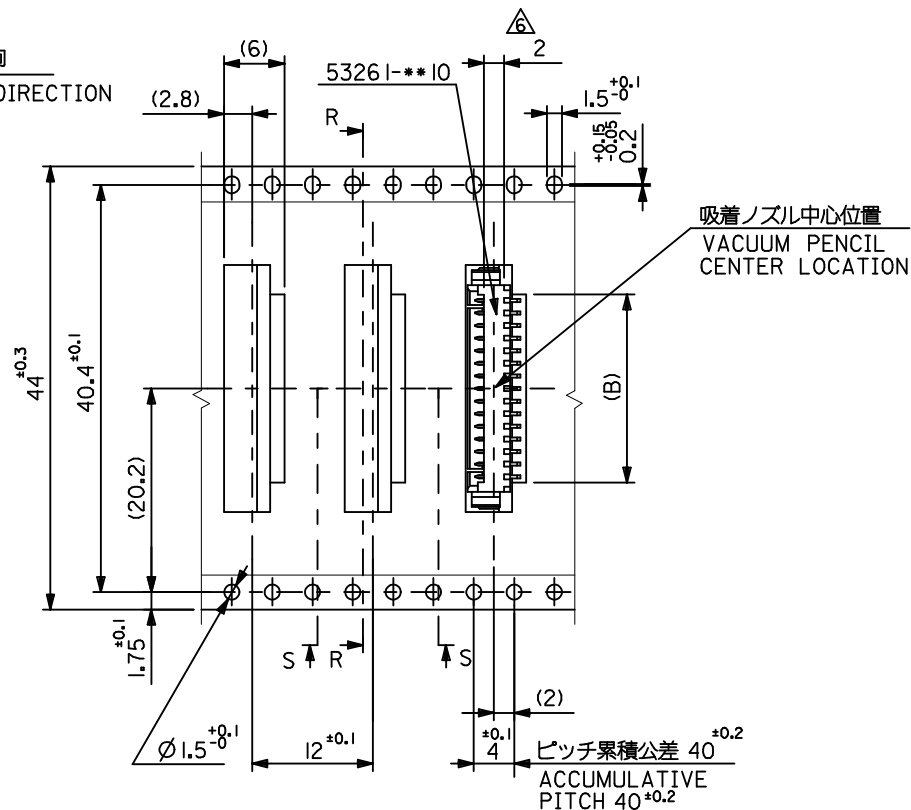
10 9 8 7 6 5 4 3 2 1

引き出し方向
PULL OUT DIRECTION

トップテープ
TOP TAPE

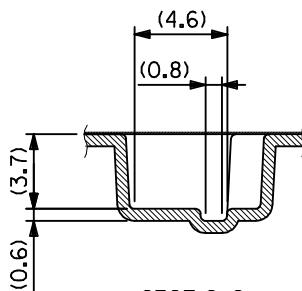


SECT:R-R



吸着ノズル中心位置
VACUUM PENCIL
CENTER LOCATION

ピッチ累積公差 40
ACCUMULATIVE
PITCH 40



SECT:S-S

44mm幅キャリアテープ
44mm WIDTH CARRIER TAPE

44	44.4	18.7	24.5	53261-I-590	I5
		17.45	23.25	53261-I-490	I4
キャリアテープ幅 CARRIER TAPE WIDTH	C	B	A	ENG. NO.	極数 CKT.

REVISED EC NO: J2014-1616 DRWN: TYAJIMA01 CHKD: KASAKAWA APPR: NUKITA G	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± ---	TYAJIMA01	2014/04/28	TITLE 1.25 W/B CONN. WAFER ASSY FOR SMT. EMBOSSED TAPE PACKAGE molex				
		10 OVER 30 UNDER	± ---	CHECKED BY	DATE					
		30 OVER	± ---	APPROVED BY	DATE					
		ANGULAR ± --- °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE NOTES		SD-53261-055		3 OF 3			
			SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

9 8 7 6 5 4 3 2